

## Molding Type Module IGBT 2-in 1-Package, 1200 V, 75 A


**INT-A-PAK**

**RoHS**  
COMPLIANT

### FEATURES

- High short circuit capability, self limiting to 6 x I
- 10  $\mu$ s short circuit capability
- $V_{CE(on)}$  with positive temperature coefficient
- Low inductance case
- Fast and soft reverse recovery antiparallel FWD
- Isolated copper baseplate using DCB (Direct Copper Bonding) technology
- Material categorization: for definitions of compliance please see [www.vishay.com/doc?99912](http://www.vishay.com/doc?99912)

### TYPICAL APPLICATIONS

- AC inverter drivers
- Electronic welders
- Switching mode power supplies

### DESCRIPTION

Vishay's IGBT power module provides ultra low conduction loss as well as short circuit ruggedness. It is designed for applications such as general inverters and UPS.

PRIMARY CHARACTERISTICS	
$V_{CES}$	1200 V
$I_C$ at $T_C = 80^\circ\text{C}$	75 A
$V_{CE(on)}$ (typical) at $I_C = 75\text{ A}$ , $T_J = 25^\circ\text{C}$	1.90 V
Speed	8 kHz to 30 kHz
Package	INT-A-PAK
Circuit configuration	Half bridge

ABSOLUTE MAXIMUM RATINGS ( $T_C = 25^\circ\text{C}$ unless otherwise noted)				
PARAMETER	SYMBOL	TEST CONDITIONS	MAX.	UNITS
Collector to emitter voltage	$V_{CES}$		1200	V
Gate to emitter voltage	$V_{GES}$		$\pm 20$	
Collector current	$I_C$	$T_C = 25^\circ\text{C}$	150	A
		$T_C = 80^\circ\text{C}$	75	
Pulsed collector current	$I_{CM}^{(1)}$	$t_p = 1\text{ ms}$	150	A
Diode continuous forward current	$I_F$	$T_C = 80^\circ\text{C}$	75	
Diode maximum forward current	$I_{FM}^{(1)}$	$t_p = 1\text{ ms}$	150	A
Maximum power dissipation	$P_D$	$T_J = 150^\circ\text{C}$	543	
Short circuit withstand time	$T_{SC}$	$T_J = 125^\circ\text{C}$	10	$\mu\text{s}$
$I^2t$ -value, diode		$V_R = 0\text{ V}$ , $t = 10\text{ ms}$ , $T_J = 125^\circ\text{C}$	1050	$\text{A}^2\text{s}$
RMS isolation voltage	$V_{ISOL}$	$f = 50\text{ Hz}$ , $t = 1\text{ min}$	2500	V
Maximum junction temperature	$T_J$		+150	$^\circ\text{C}$

**Note**

(1) Repetitive rating: pulse width limited by maximum junction temperature

IGBT ELECTRICAL SPECIFICATIONS ( $T_C = 25^\circ\text{C}$ unless otherwise noted)						
PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNITS
Collector to emitter breakdown voltage	$V_{(BR)CES}$	$V_{GE} = 0\text{ V}$ , $I_C = 1.0\text{ mA}$ , $T_J = 25^\circ\text{C}$	1200	-	-	V
Collector to emitter voltage	$V_{CE(on)}$	$V_{GE} = 15\text{ V}$ , $I_C = 75\text{ A}$ , $T_J = 25^\circ\text{C}$	-	1.9	2.35	
		$V_{GE} = 15\text{ V}$ , $I_C = 75\text{ A}$ , $T_J = 125^\circ\text{C}$	-	2.1	-	
Gate to emitter threshold voltage	$V_{GE(th)}$	$V_{CE} = V_{GE}$ , $I_C = 3.0\text{ mA}$ , $T_J = 25^\circ\text{C}$	5.0	6.2	7.0	mA
Collector cut-off current	$I_{CES}$	$V_{CE} = V_{CES}$ , $V_{GE} = 0\text{ V}$ , $T_J = 25^\circ\text{C}$	-	-	5.0	
Gate to emitter leakage current	$I_{GES}$	$V_{GE} = V_{GES}$ , $V_{CE} = 0\text{ V}$ , $T_J = 25^\circ\text{C}$	-	-	400	

SWITCHING CHARACTERISTICS							
PARAMETER	SYMBOL	TEST CONDITIONS		MIN.	TYP.	MAX.	UNITS
Turn-on delay time	$t_{d(on)}$	$V_{CC} = 600 \text{ V}$ , $I_C = 75 \text{ A}$ , $R_g = 10 \Omega$ , $V_{GE} = \pm 15 \text{ V}$ , $T_J = 25^\circ\text{C}$	-	305	-	-	ns
Rise time	$t_r$		-	67	-	-	
Turn-off delay time	$t_{d(off)}$		-	328	-	-	
Fall time	$t_f$		-	187	-	-	
Turn-on switching loss	$E_{on}$		-	6.74	-	-	mJ
Turn-off switching loss	$E_{off}$		-	4.25	-	-	
Turn-on delay time	$t_{d(on)}$	$V_{CC} = 600 \text{ V}$ , $I_C = 75 \text{ A}$ , $R_g = 10 \Omega$ , $V_{GE} = \pm 15 \text{ V}$ , $T_J = 125^\circ\text{C}$	-	311	-	-	ns
Rise time	$t_r$		-	67	-	-	
Turn-off delay time	$t_{d(off)}$		-	347	-	-	
Fall time	$t_f$		-	337	-	-	
Turn-on switching loss	$E_{on}$		-	9.75	-	-	mJ
Turn-off switching loss	$E_{off}$		-	7.05	-	-	
Input capacitance	$C_{ies}$	$V_{GE} = 0 \text{ V}$ , $V_{CE} = 25 \text{ V}$ , $f = 1.0 \text{ MHz}$ , $T_J = 25^\circ\text{C}$	-	5.52	-	-	nF
Output capacitance	$C_{oes}$		-	0.40	-	-	
Reverse transfer capacitance	$C_{res}$		-	0.26	-	-	
SC data	$I_{SC}$	$t_s \leq 10 \mu\text{s}$ , $V_{GE} = 15 \text{ V}$ , $T_J = 125^\circ\text{C}$ , $V_{CC} = 900 \text{ V}$ , $V_{CEM} \leq 1200 \text{ V}$	-	350	-	-	A
Internal gate resistance	$R_{GINT}$		-	3	-	-	$\Omega$
Stray inductance	$L_{CE}$		-	-	-	30	nH
Module lead resistance, terminal to chip	$R_{CC'EE'}$		-	0.75	-	-	$\text{m}\Omega$

DIODE ELECTRICAL SPECIFICATIONS ( $T_C = 25^\circ\text{C}$ unless otherwise noted)							
PARAMETER	SYMBOL	TEST CONDITIONS		MIN.	TYP.	MAX.	UNITS
Forward voltage	$V_F$	$I_F = 75 \text{ A}$	$T_J = 25^\circ\text{C}$	-	1.78	2.18	V
			$T_J = 125^\circ\text{C}$	-	1.85	-	
Reverse recovery charge	$Q_{rr}$	$I_F = 75 \text{ A}$ , $V_R = 600 \text{ V}$ , $dI_F/dt = 1300 \text{ A}/\mu\text{s}$ $V_{GE} = -15 \text{ V}$	$T_J = 25^\circ\text{C}$	-	4.0	-	$\mu\text{C}$
Peak reverse recovery current	$I_{rr}$		$T_J = 125^\circ\text{C}$	-	9.3	-	
			$T_J = 25^\circ\text{C}$	-	55	-	A
			$T_J = 125^\circ\text{C}$	-	73	-	
Reverse recovery energy	$E_{rec}$		$T_J = 25^\circ\text{C}$	-	2.98	-	mJ
			$T_J = 125^\circ\text{C}$	-	4.46	-	

THERMAL AND MECHANICAL SPECIFICATIONS							
PARAMETER	SYMBOL	TEST CONDITIONS		MIN.	TYP.	MAX.	UNITS
Maximum junction temperature	$T_J$			-	-	150	$^\circ\text{C}$
Storage temperature range	$T_{Stg}$			-40	-	125	$^\circ\text{C}$
Junction to case per $\frac{1}{2}$ module	IGBT Diode	$R_{thJC}$		-	-	0.23	K/W
Case to sink (conductive grease applied)	$R_{thCS}$			-	-	0.33	
Mounting torque			Power terminal screw: M5	2.5 to 5.0			Nm
			Mounting screw: M6	3.0 to 5.0			
Weight		Weight of module		-	150	-	g

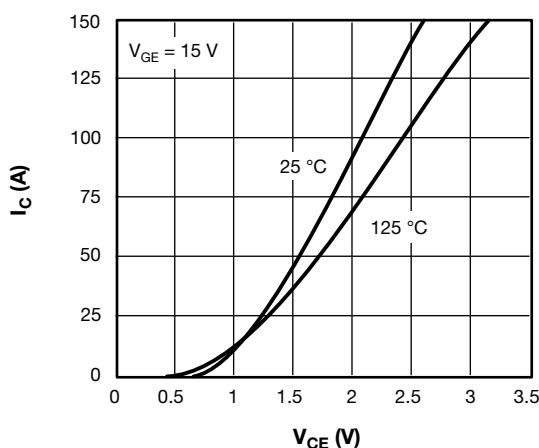


Fig. 1 - IGBT Typical Output Characteristics

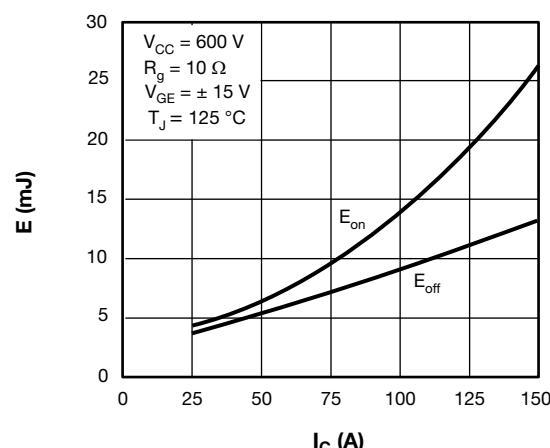


Fig. 3 - IGBT Switching Loss vs.  $I_C$

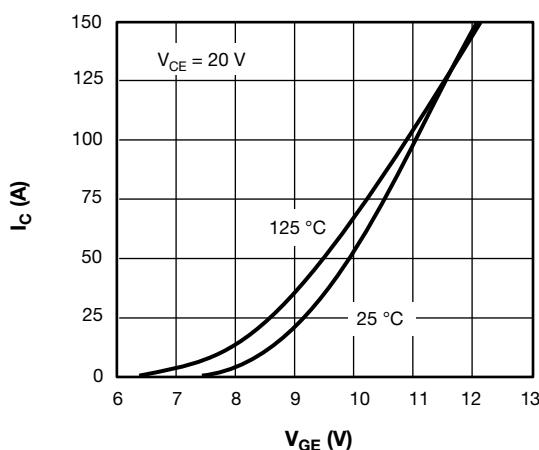


Fig. 2 - IGBT Typical Transfer Characteristics

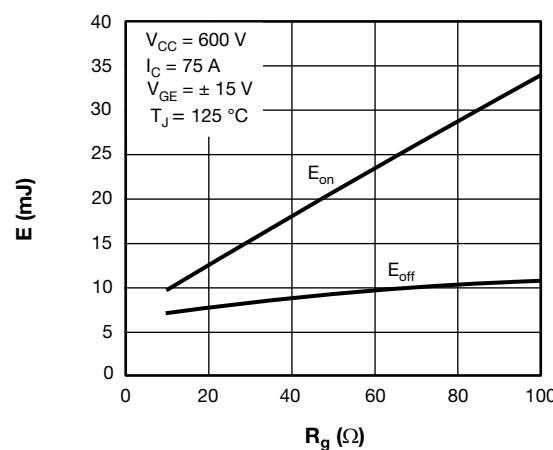


Fig. 4 - IGBT Switching Loss vs.  $R_g$

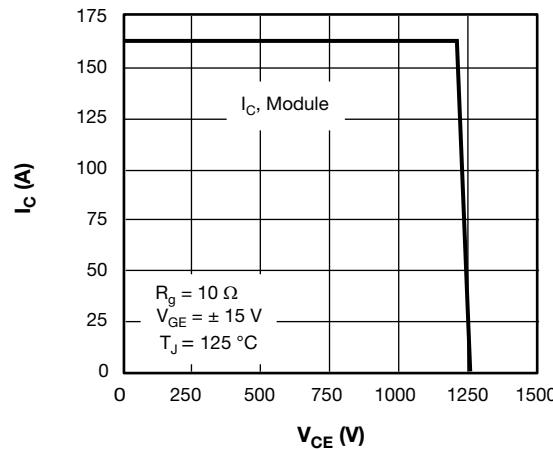


Fig. 5 - RBSOA

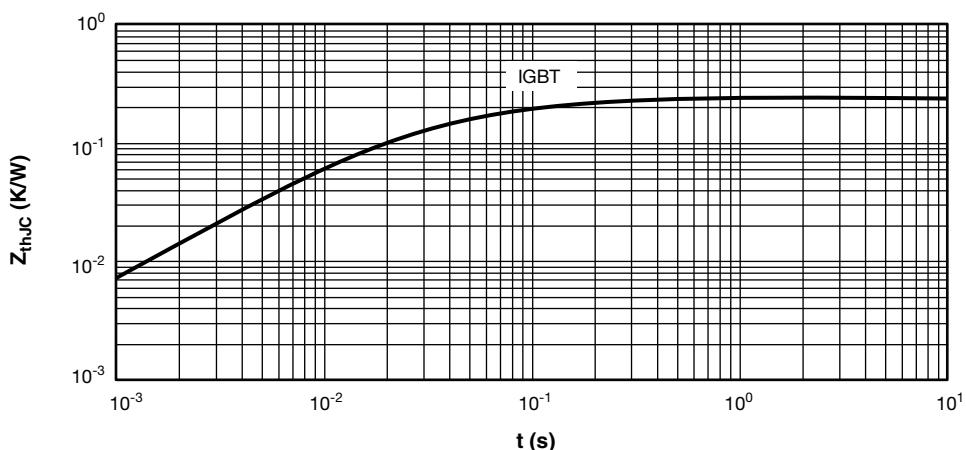


Fig. 6 - IGBT Transient Thermal Impedance

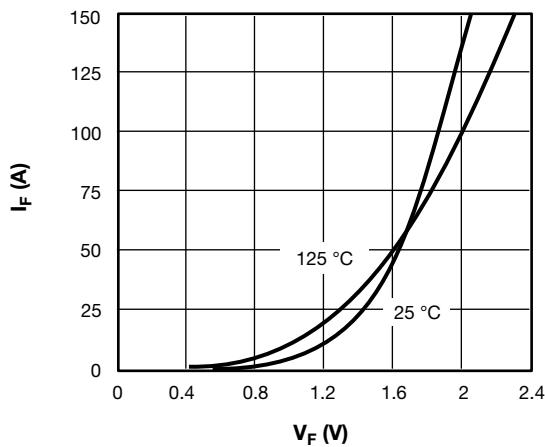


Fig. 7 - Typical Diode Forward Characteristics

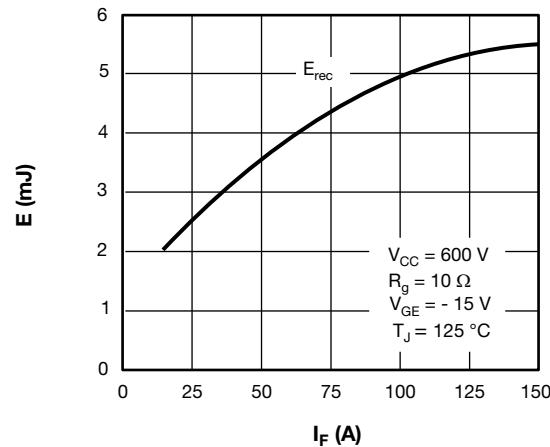


Fig. 8 - Diode Switching Loss vs.  $I_F$

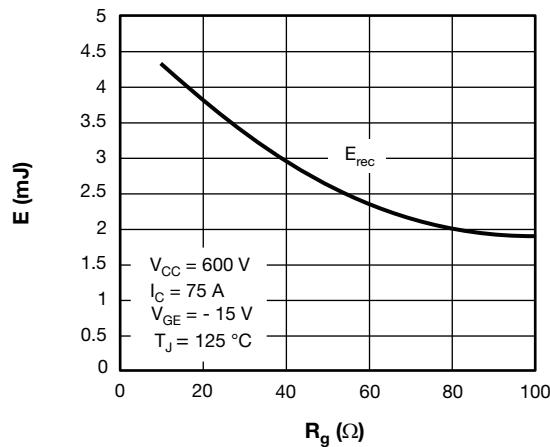


Fig. 9 - Diode Switching Loss vs.  $R_g$

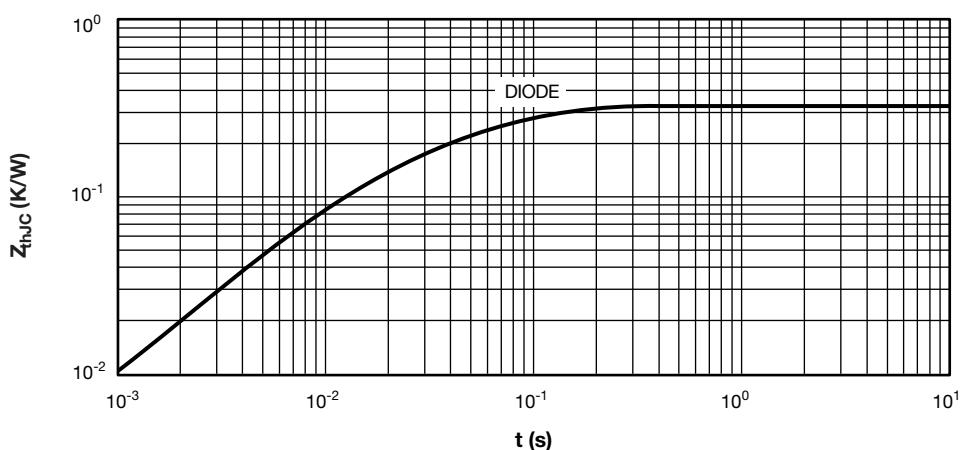
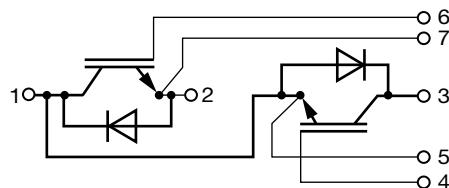


Fig. 10 - Diode Transient Thermal Impedance

## CIRCUIT CONFIGURATION

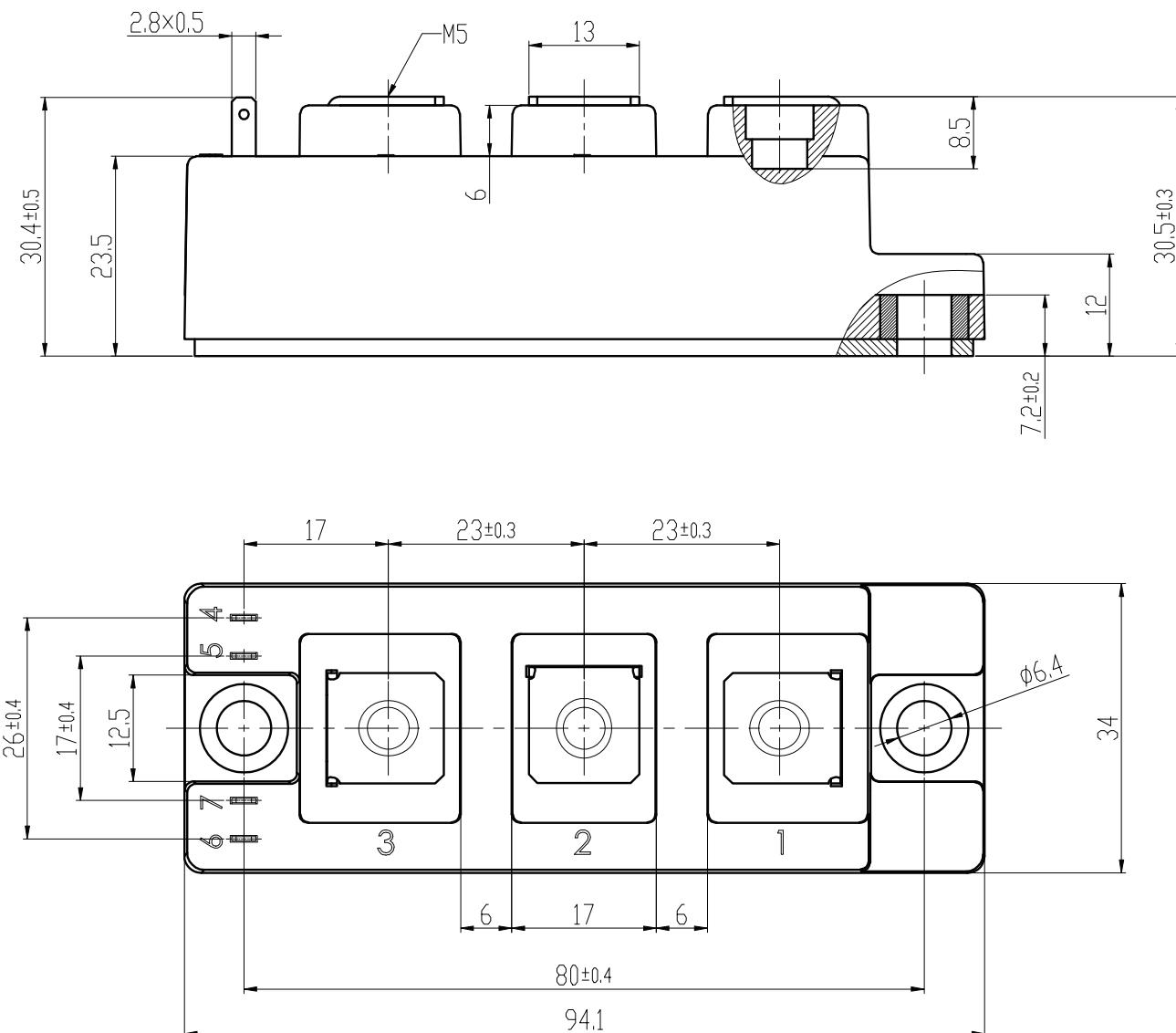


LINKS TO RELATED DOCUMENTS	
Dimensions	<a href="http://www.vishay.com/doc?95524">www.vishay.com/doc?95524</a>



## INT-A-PAK

**DIMENSIONS** in millimeters (inches)



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